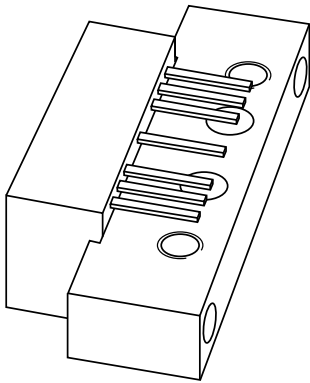


DATA SHEET



BGD502

550 MHz, 18.5 dB gain power
doubler amplifier

Product specification
Supersedes data of 1995 Oct 25

2001 Nov 15



550 MHz, 18.5 dB gain power doubler amplifier

BGD502

FEATURES

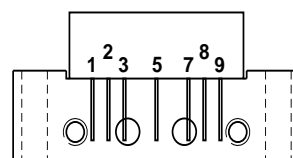
- Excellent linearity
- Extremely low noise
- Silicon nitride passivation
- Rugged construction
- TiPtAu metallized crystals ensure optimal reliability.

DESCRIPTION

Hybrid amplifier modules for CATV systems operating over a frequency range of 40 to 550 MHz at a voltage supply of 24 V (DC).

PINNING - SOT115J

PIN	DESCRIPTION
1	input
2, 3	common
5	+V _B
7, 8	common
9	output



Side view

MSA319

Fig.1 Simplified outline.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
G _p	power gain	f = 50 MHz	18	19	dB
		f = 550 MHz	18.8	20.8	dB
I _{tot}	total current consumption (DC)	V _B = 24 V	—	435	mA

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V _i	RF input voltage	—	65	dBmV
T _{stg}	storage temperature	−40	+100	°C
T _{mb}	operating mounting base temperature	−20	+100	°C

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CHARACTERISTICS

Table 1 Bandwidth 40 to 550 MHz; $V_B = 24\text{ V}$; $T_{mb} = 35\text{ °C}$; $Z_S = Z_L = 75\text{ }\Omega$.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
G_p	power gain	$f = 50\text{ MHz}$	18	–	19	dB
		$f = 550\text{ MHz}$	18.8	–	20.8	dB
SL	slope cable equivalent	$f = 40\text{ to }550\text{ MHz}$	0.2	–	2.2	dB
FL	flatness of frequency response	$f = 40\text{ to }550\text{ MHz}$	–	–	± 0.3	dB
s_{11}	input return losses	$f = 40\text{ to }80\text{ MHz}$	20	–	–	dB
		$f = 80\text{ to }160\text{ MHz}$	19	–	–	dB
		$f = 160\text{ to }550\text{ MHz}$	18	–	–	dB
s_{22}	output return losses	$f = 40\text{ to }80\text{ MHz}$	20	–	–	dB
		$f = 80\text{ to }160\text{ MHz}$	19	–	–	dB
		$f = 160\text{ to }550\text{ MHz}$	18	–	–	dB
s_{21}	phase response	$f = 50\text{ MHz}$	+135	–	+225	deg
CTB	composite triple beat	77 channels flat; $V_o = 44\text{ dBmV}$; measured at 547.25 MHz	–	–	–65	dB
X_{mod}	cross modulation	77 channels flat; $V_o = 44\text{ dBmV}$; measured at 55.25 MHz	–	–	–68	dB
CSO	composite second order distortion	77 channels flat; $V_o = 44\text{ dBmV}$; measured at 548.5 MHz	–	–	–62	dB
d_2	second order distortion	note 1	–	–	–72	dB
V_o	output voltage	$d_{im} = -60\text{ dB}$; note 2	64	–	–	dBmV
NF	noise figure	$f = 550\text{ MHz}$	–	–	8	dB
I_{tot}	total current consumption (DC)	note 3	–	415	435	mA

Notes

1. $f_p = 55.25\text{ MHz}$; $V_p = 44\text{ dBmV}$; $f_q = 493.25\text{ MHz}$; $V_q = 44\text{ dBmV}$; measured at $f_p + f_q = 548.5\text{ MHz}$.
2. Measured according to DIN45004B: $f_p = 540.25\text{ MHz}$; $V_p = V_o$; $f_q = 547.25\text{ MHz}$; $V_q = V_o - 6\text{ dB}$; $f_r = 549.25\text{ MHz}$; $V_r = V_o - 6\text{ dB}$; measured at $f_p + f_q - f_r = 538.25\text{ MHz}$.
3. The module normally operates at $V_B = 24\text{ V}$, but are able to withstand supply transients up to $V_B = 30\text{ V}$.

550 MHz, 18.5 dB gain power doubler amplifier

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Table 2 Bandwidth 40 to 450 MHz; $V_B = 24\text{ V}$; $T_{mb} = 35\text{ °C}$; $Z_S = Z_L = 75\text{ }\Omega$.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
G_p	power gain	$f = 50\text{ MHz}$	18	–	19	dB
		$f = 450\text{ MHz}$	18.6	–	20.6	dB
SL	slope cable equivalent	$f = 40\text{ to }450\text{ MHz}$	0.2	–	1.8	dB
FL	flatness of frequency response	$f = 40\text{ to }450\text{ MHz}$	–	–	± 0.3	dB
S_{11}	input return losses	$f = 40\text{ to }80\text{ MHz}$	20	–	–	dB
		$f = 80\text{ to }160\text{ MHz}$	19	–	–	dB
		$f = 160\text{ to }450\text{ MHz}$	18	–	–	dB
S_{22}	output return losses	$f = 40\text{ to }80\text{ MHz}$	20	–	–	dB
		$f = 80\text{ to }160\text{ MHz}$	19	–	–	dB
		$f = 160\text{ to }450\text{ MHz}$	18	–	–	dB
S_{21}	phase response	$f = 50\text{ MHz}$	+135	–	+225	deg
CTB	composite triple beat	60 channels flat; $V_o = 46\text{ dBmV}$; measured at 445.25 MHz	–	–	–67	dB
CSO	composite second order distortion	60 channels flat; $V_o = 46\text{ dBmV}$; measured at 446.5 MHz	–	–	–60	dB
X_{mod}	cross modulation	60 channels flat; $V_o = 46\text{ dBmV}$; measured at 55.25 MHz	–	–	–67	dB
d_2	second order distortion	note 1	–	–	–75	dB
V_o	output voltage	$d_{im} = -60\text{ dB}$; note 2	67	–	–	dBmV
NF	noise figure	$f = 450\text{ MHz}$	–	–	7	dB
I_{tot}	total current consumption (DC)	note 3	–	415	435	mA

Notes

1. $f_p = 55.25\text{ MHz}$; $V_p = 46\text{ dBmV}$; $f_q = 391.25\text{ MHz}$; $V_q = 46\text{ dBmV}$; measured at $f_p + f_q = 446.5\text{ MHz}$.
2. Measured according to DIN45004B: $f_p = 440.25\text{ MHz}$; $V_p = V_o$; $f_q = 447.25\text{ MHz}$; $V_q = V_o - 6\text{ dB}$; $f_r = 449.25\text{ MHz}$; $V_r = V_o - 6\text{ dB}$; measured at $f_p + f_q - f_r = 438.25\text{ MHz}$.
3. The modules normally operate at $V_B = 24\text{ V}$, but are able to withstand supply transients up to $V_B = 30\text{ V}$.

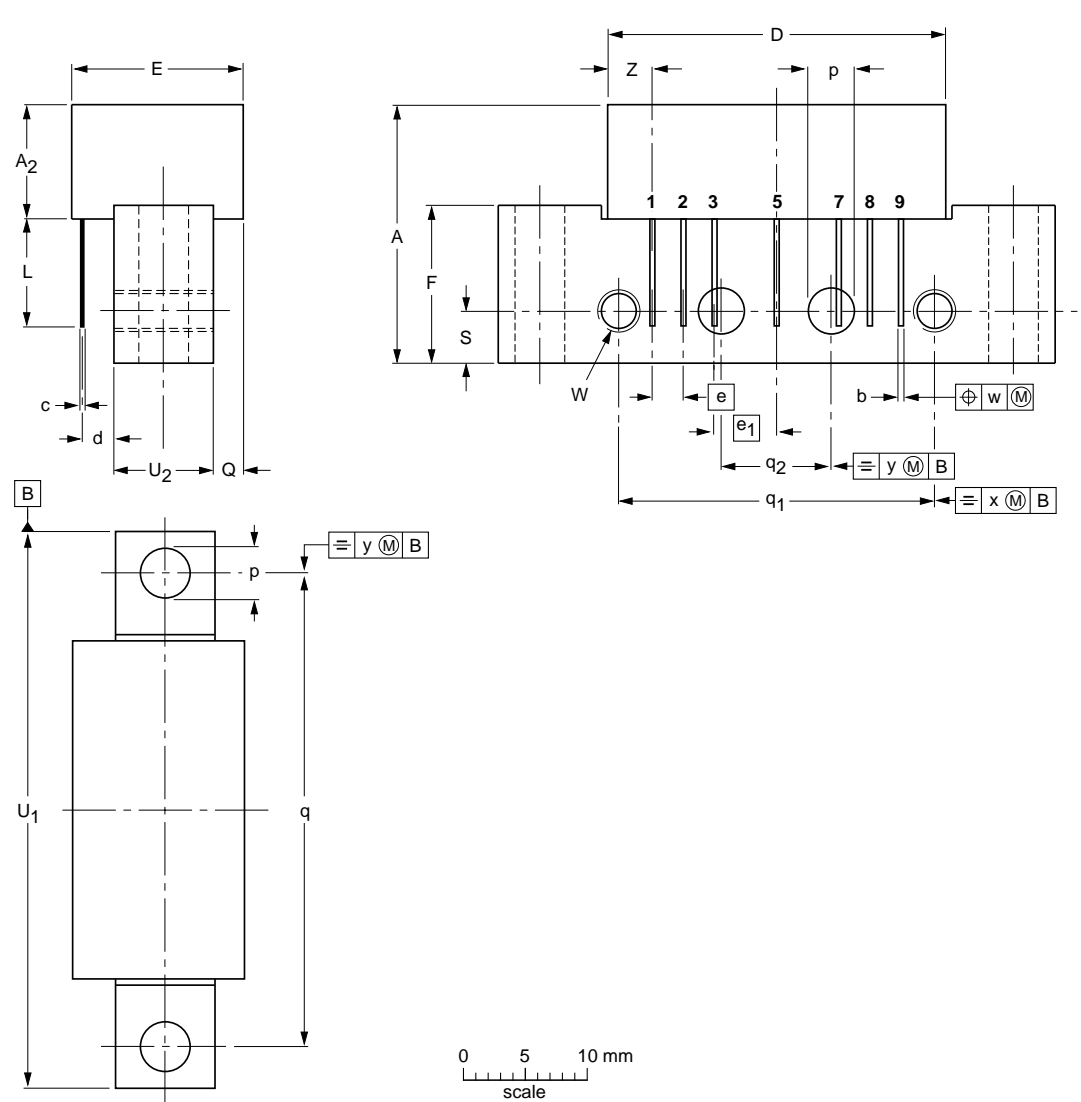
550 MHz, 18.5 dB gain power doubler
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PACKAGE OUTLINE

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes;
2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₂ max.	b	c	D max.	d	E max.	e	e ₁	F	L min.	p	Q max.	q	q ₁	q ₂	S	U ₁	U ₂	W	w	x	y	Z max.
mm	20.8	9.5	0.51 0.38	0.25	27.2	2.04 2.54	13.75	2.54	5.08	12.7	8.8	4.15 3.85	2.4	38.1	25.4	10.2	4.2	44.75 44.25	8.2 7.8	6-32 UNC	0.25	0.7	0.1	3.8

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT115J						04-02-04 10-06-18

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DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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